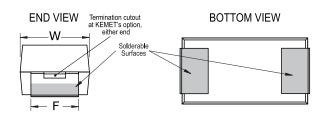
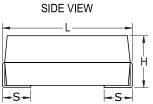


T493X337K010BC6420

Aliases (DLA Drawing 07016-054KBCC)

T493 HRA, Tantalum, MnO2 Tantalum, HRA, 330 uF, 10%, 10 VDC, SMD, MnO2, Molded, DLA Drawing, B (0.1%/1000 Hrs), 100 mOhms, 7343, 4.3 mm, 1.3 mm





S F

		SCIP Number
- S-	-S-	Termination
	Click here for the 3D model.	AEC-Q200
		Typical Component
Dimensions		Specifications
Dimensions L	7.3mm +/-0.3mm	Specifications Capacitance
Dimensions L W	7.3mm +/-0.3mm 4.3mm +/-0.3mm	
L	•	Capacitance

1.3mm +/-0.3mm

2.4mm +/-0.1mm

Packaging Specifications		
Packaging	T&R, 178mm	
Packaging Quantity	500	

General Information	
Series	T493 HRA
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, DLA Drawing
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov /
SCIP Number	652b281f-d242-4453-bc44-06 55d646cec3
Termination	Hot Solder Dipped
AEC-Q200	No
Typical Component Weight	654.04 mg

Specifications	
Capacitance	330 uF
Tolerance	10%
Voltage DC	10 VDC (85C), 6.7 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	8% 120Hz 25C
Failure Rate	B (0.1%/1000 Hrs)
ESR	0.1 Ohms (100kHz 25C)
Ripple Current	1285 mA (rms, 100kHz 25C)
Leakage Current	33 uA (5min 25°C)
Testing and Reliability	10 Cycles Surge Current Testing At -55C And +85C Before Weibull

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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